



NEWS RELEASE

Credo to Showcase 1.6T Optical Connectivity Solutions for AI Scale-Out Fabrics at ECOC 2026

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SAN JOSE, Calif.--(BUSINESS WIRE)-- **Credo Technology Group Holding Ltd** (Credo) (NASDAQ: CRDO), an innovator in providing connectivity at scale through fast, reliable, and energy-efficient system solutions, will showcase its latest optical connectivity technologies and silicon photonics innovations at ECOC 2026, taking place September 21-23 at FYCMA in Málaga, Spain.

Credo Booth Demonstration Highlights (Booth #2056)

- **1.6T 2xDR4 Fully Retimed Module**

Powered by **Credo's Cardinal 802 1.6T DSP** and **Kfir 200G silicon photonics PIC**, the solution delivers advanced optical connectivity to support the growing bandwidth demands of AI and cloud infrastructure.

- **800G & 1.6T ZeroFlap Optics + PILOT**

High-performance optical interconnect solutions featuring real-time link health monitoring and root-cause diagnostics through the Credo PILOT observability platform, enabling greater visibility and reliability at AI scale.

Presentations

- **Workshop: Can Fast Narrow Channels Keep Rising Without Limit or Will Slow and Wide Become the Winner?**
September 20 at 4:00 p.m., PV-R Multipurpose Room
Credo Speaker: Mohsen Asad, Senior Director of Core Technology
- **Presentation: Scaling Optical Reliability with Bandwidth Across AI Clusters**
September 23 at 2:40 p.m., Market Focus Theatre

Credo Speaker : Rajan Pai, Vice President of Optical Solutions

To request a meeting or product demo, please contact sales@credosemi.com.

About Credo

Credo's mission is to transform connectivity at scale through fast, reliable, and energy-efficient system solutions. Our high-speed copper and optical interconnect technologies deliver industry-leading power and performance from chip to cluster to meet the ever-expanding data infrastructure demands of AI.

Our vertically integrated connectivity portfolio is comprised of our flagship purple ZeroFlap (ZF) Active Electrical Cables (AECs) and ZF optical transceivers; optical components including silicon photonics-based photonic integrated circuits (SiPho PICs) and DSPs; OmniConnect AI memory and chip-to-chip interconnect; and retimers for Ethernet and PCIe—supported by our PILOT diagnostic and analytics software platform. Credo innovations enable our customers to connect the systems that connect the world.

For more information, please visit <https://www.credosemi.com>. Follow Credo on [LinkedIn](#).

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Source: Credo